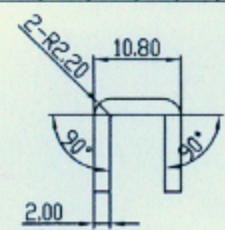


Notes:
 1. Material: H65, M6.0;
 2. Plating: Ni plated on the surface is more than 2um;

REVISION RECORD				
REV	ECN	DESCRIPTION	DRFT	DATE

- Notes:
1. Pitch: 15.2mm, Poles: 2-10P;
 2. Material: T2Y2;
 3. Plating: Cu plated at the bottom is more than 2um; Sn plated at the bottom is more than 4um;
 4. Undimensioned Tolerances:

Pitch range in mm		Nominal dimension range in mm					—
to	from	to	from	to	from	to	—
6	10	6	10	10	150	150	∩
10	24	10	30	60	100	150	□
24	30	30	60	100	150	150	□
30	60	60	100	150	150	150	□
60	100	100	150	150	150	150	□
100	150	150	150	150	150	150	□
150	150	150	150	150	150	150	□
150	150	150	150	150	150	150	□



Current carrier and screws should be packed individually, which must be put in the same box

载流体和螺丝分开包装, 必须放于同一内盒



2	FBI10-15 M6 "—" Screws	S000004640 (H)	H65	Ni															
1	FBIXX-15 Current carrier	6013BXX060 (H)	T2Y2	SnCe															
ITEM	NAME OF PART	NO. OF PART	Q'TY	MATERIAL	NOTES														
<table border="1"> <tr> <td>DRW</td> <td>DATE</td> <td>06/16/08</td> </tr> <tr> <td>CHKD</td> <td>DATE</td> <td>06/15/11</td> </tr> <tr> <td>MFD</td> <td>DATE</td> <td></td> </tr> <tr> <td>APPRV</td> <td>DATE</td> <td>06/15/11</td> </tr> <tr> <td colspan="3">MATERIAL :</td> </tr> </table>		DRW	DATE	06/16/08	CHKD	DATE	06/15/11	MFD	DATE		APPRV	DATE	06/15/11	MATERIAL :			DEGSON 宁波高正电子有限公司 DEGSON ELECTRONICS CO., LTD.		
DRW	DATE	06/16/08																	
CHKD	DATE	06/15/11																	
MFD	DATE																		
APPRV	DATE	06/15/11																	
MATERIAL :																			
TOLERANCES EXCEPT AS NOTED: .012 ± .005 .020 ± .005 .030 ± .005		NAME: FBIXX-15																	
ANGLES ± 1° THIRD ANGLE PROJECTION		DRAWING NO. FBIXX-15-E01 /PART NO.																	
FINISH: SCALE: 1:1		DO NOT SCALE DRAWING SHEET 1 OF 1																	
DETACHED LISTS		SIZE: A3 REV: TO 10/20/08																	